

01-03-2002

12/19/01

ASSIGNMENT



101932849



To: Honorable Commissioner of Patents and Trademarks:

Please record the attached original document(s) or copy thereof.

- 1. Name of conveying party(ies)
 - a) Wee Liang Lien
- 2. Name and address of receiving party(ies):
 - a) Name: Institute of Microelectronics
 - Address: 11 Science Park Road
Singapore Science Park II
Singapore 117685

- 3. Nature of conveyance

<input checked="" type="checkbox"/> Assignment	<input type="checkbox"/> Merger
<input type="checkbox"/> Security Agreement	<input type="checkbox"/> Change of Name
<input type="checkbox"/> Other _____	<input type="checkbox"/> License Agreement

10024750

Execution Date: a) August 29, 2001

- 4. Application Number(s) or Patent Number(s):

The title of the (new) application is: CIRCUIT FOR MEASURING CHANGES IN CAPACITOR GAP USING A SWITCHED CAPACITOR TECHNIQUE

- 5. Please send all correspondence concerning this (these) documents to:

Brian R. Coleman
 OPPENHEIMER WOLFF & DONNELLY, LLP
 1400 Page Mill Road
 Palo Alto, CA 94304

- 6. Total number of applications and patents involved: 1

- 7. Total fee (37 CFR 3.41): \$40.00

- Enclosed is Check No. _____ in the amount of \$ _____
- Authorized to be charged to Deposit Account No. 02-3964
(Order No 60015-301001)

- 8. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Date: December 19, 2001

Daphne L. Burton
 Registration No. 45,323

01/02/2002 GTDM11 00000138 023964 10024750
 01 FC:581 40.00 CH

ASSIGNMENT

I, Wee Liang Lien as a below-named inventor, for good and valuable consideration, receipt of which is hereby acknowledged, have assigned and do hereby assign to:

**Institute of Microelectronics
11 Science Park Road, Singapore Science Park II, Singapore 117685**

A Singapore CORPORATION (hereinafter referred to as Assignee), its successors, assigns and legal representatives, the entire right, title and interest in and to all subject matter invented by Wee Liang Lien and disclosed and/or claimed in an application for Letters Patent of the United States of America Serial No. _____ filed _____, entitled:

“CIRCUIT FOR MEASURING CHANGES IN CAPACITOR GAP USING A SWITCHED CAPACITOR TECHNIQUE”

and signed by me

On the date set forth below;
on the DATE OF SIGNING DECLARATION

and in and to any and all divisions, reissues, continuations and extensions thereof; and in and to all corresponding applications for Letters Patent and all Convention and Treaty Rights of any kind, in all countries throughout the world, for all such subject matter.

I hereby authorize and request that the Patent Office Officials in the United States, and in countries foreign to the United States, issue any and all of said Letters Patent or similar documents, when granted, to said Assignee, as the Assignee of our entire right, title and interest in and to the same, for the sole use and enjoyment of said Assignee, its successors and assigns.

Further, I agree that I will communicate to said Assignee, or its representatives, any facts known to me respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisions, continuations, substitutions, and renewal reexamination and reissue applications, execute all necessary Assignment papers to cause any and all of said Letters Patent to be issued to said Assignee, make all rightful oaths and generally do everything necessary or desirable to aid said Assignee, its successors and assigns, to obtain and enforce proper protection for said invention in the United States.

The undersigned hereby authorizes the firm of OPPENHEIMER WOLFF & DONNELLY LLP to correct errors in this assignment or to insert any further identification or other information (including the serial number and filing date) necessary or desirable to make this assignment suitable for recordal in the United States Patent Office, and any Patent Office foreign to the United States.

In Testimony Whereof, I hereunto set my hand.

SIGNATURES

Inventor's Signature: *Wee Liang Lien* Date: 29 Aug 2001

Typed Name: Wee Liang Lien

Home Address: BLK 50, TEBAN GARDENS, #12-573, SINGAPORE 600050

Citizenship: Singapore